



## **Customer Notification**

# **RL78/F14 Family**

## **16-bit Single-Chip Microcontroller**

## **Injected Current Specification**

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Table of Contents

1.	<b>Related Products</b> .....	4
2.	<b>Port Pin Groups</b> .....	5
3.	<b>Electrical Specification for Injected Current</b> .....	6
4.	<b>The influence on an adjacent pin caused by the Injected Current</b> .....	8
5.	<b>Valid Specification</b> .....	10
6.	<b>Revision History</b> .....	11

## 1. Related Products

Series	Pin Count	Package Type	Product Name	Temperature Grades
RL78/F14	30-pins	SSOP	R5F10PAD /E,	L, K, Y
	32-pins	QFN	R5F10PBD /E,	
	48-pins	QFP	R5F10PGD /E /F /G /H /J	
		QFN		
	64-pins	QFP	R5F10PLE /F /G /H /J	
	80-pins	QFP	R5F10PME /F /G /H /J	
	100-pins	QFP	R5F10PPE /F /G /H /J	

## 2. Port Pin Groups

Depending on the products the corresponding ports are split into four groups:

Products		Port Group A	Port Group B	Port Group C	Port Group D
30 pin	R5F10PAD, R5F10PAE	P10-P17, P30, P41	P120, P125	P80, P85-P87	P81-P84
32 pin	R5F10PBD, R5F10PBE,	P10-P17, P30, P41, P60-P63	P120, P125	P80, P85	P81-P84
48 pin	R5F10PGD, R5F10PGE, R5F10PGF	P00, P10-P17, P30-P32, P41, P60-P63, P70-P73, P140	P120, P125	P80, P85-P87, P90-P92	P81-P84
	R5F10PGG, R5F10PGH, R5F10PGJ	P00, P10-P17, P30-P32, P41, P60-P63, P140	P70-P73 P120, P125	P80, P85-P87, P90-P92	P81-P84
64 pin	R5F10PLE, R5F10PLF,	P00, P10-P17, P30-P32, P41-P43, P50-P53, P60-P63, P70-P77, P140	P96, P120, P125	P80, P85-P87, P90-P95	P81-P84
	R5F10PLG, R5F10PLH, R5F10PLJ	P00, P10-P17, P30-P32, P41-P43, P50-P53, P60-P63, P75-P77, P140	P70-P74, P120, P125	P80, P85-P87, P90-P96	P81-P84
80 pin	R5F10PME, R5F10PMF,	P00-P02, P10-P17, P30-P32, P41-P47, P50-P57, P60-P67, P70-P77, P126, P140	P96-P97, P120, P125	P80, P85-P87, P90-P95	P81-P84
	R5F10PMG, R5F10PMH, R5F10PMJ	P00-P02, P10-P17, P30-P32, P41-P47, P50-P57, P60-P67, P75-P77, P126, P140	P70-P74,, P120, P125	P80, P85-P87, P90-P97	P81-P84
100 pin	R5F10PPE, R5F10PPF, R5F10PPG, R5F10PPH, R5F10PPJ	P00-P03, P10-P17, P30-P32, P41-P47, P50-P57, P60-P67, P75-P77, P106-P107, P126- P127, P140, P150-P157	P70-P74, P120, P125	P80, P85-P87, P90-P97, P100-P105	P81-P84

### 3. Electrical Specification for Injected Current

( $T_a = -40$  to  $+150$  °C,  $2.7V \leq EV_{DD0} = EV_{DD1} = V_{DD} \leq 5.5V$ ,  $V_{SS} = EV_{SS0} = EV_{SS1} = 0V$ ) (Note 1)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Pos. Injected Current $V_{IN} > V_{DD}$ (Peak value) (Note 2)	$I_{INJP}$	Per input pin (Group A) (Note 4)			5	mA
		Per input pin (Groups B, C, D)			2	mA
Neg. Injected Current $V_{IN} < V_{SS}$ (Peak value) (Note 2)	$I_{INJN}$	Per input pin (Group A) (Note 2)			-5	mA
		Per input pin (Groups B, C, D)			-0.5	mA
Sum of all Positive Injected Currents (Peak value) (Note 3)	$\Sigma I_{INJP}$	Sum for all input pins (Group A) (Note 4)			40	mA
		Sum for all input pins (Groups B, C, D)			10	mA
Sum of all Negative Injected Currents (Peak value) (Note 3)	$\Sigma I_{INJN}$	Sum for all input pins (Group A)			-40	mA
		Sum for all input pins (Groups B, C, D)			-2.0	mA
Total Sum of all Injected Currents (Positive and Negative) (Peak value) (Note 3)	$\Sigma  I_{INJP} $ + $\Sigma  I_{INJN} $	Total Sum for all input pins (Group A) (Note 4)			40	mA
		Total Sum for all input pins (Groups B, C, D)			10	mA
Pos. Injected Current $V_{IN} > V_{DD}$ (Average value) (Note 5, 6)	$I_{INJP\ AVG}$	Per input pin (Group A) (Note 4)			0.4	mA
		Per input pin (Groups B, C, D)			0.15	mA
		Sum for all input pins (Group A) (Note 4)			4	mA
		Sum for all input pins (Group B, C, D)**			1	mA
		D**: Sum for all pins belonging to D			0.15	mA

Note 1: 64-pin and 80-pin products have  $EV_{DD0}$ ,  $EV_{SS0}$  and 100-pin product has  $EV_{DD0}$ ,  $EV_{DD1}$ ,  $EV_{SS0}$ ,  $EV_{SS1}$ . For all other products  $EV_{DD0}$  is  $V_{DD}$  and  $EV_{SS0}$  is  $V_{SS}$

Note 2: If any of the Injected Current specifications (Peak values) are exceeded even momentarily, there is a possibility to destroy the device.

Note 3: If the Sum of the Injected Current specifications (Peak values) are exceeded even momentarily, there is a possibility to destroy the device.

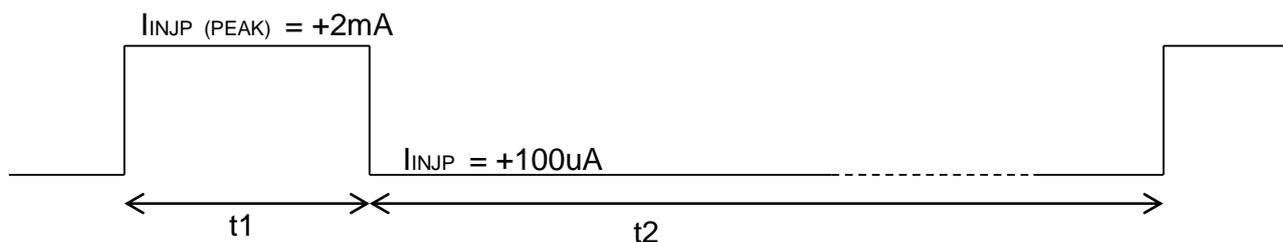
Note 4: The injected current specification ( $V_{IN} > V_{DD} = I_{INJP}$  &  $I_{INJP\ AVG}$ ) is not valid for P137/INTP0, because this port pin doesn't have the protection diode to  $V_{DD}$ .

Note 5: When the Injected Current value exceeds the allowed Injected Current value (Average value), the electrical characteristics can't be specified.

Note 6: If the allowed Injected Current value (Average value) is exceeded permanently, the product life time could be influenced.

However, when the injected current exceed the Average value but is **still below** the Peak value the product life time will not be influenced if the injected current will follow the example as given on the next page:

Example for an input belonging to Group B, C or D:



**Requirement :**

$$I_{INJP\ AVG} \leq (I_{INJP\ (PEAK)} \times t1) + (I_{INJP\ A} \times t2) / (t1 + t2) \leq 150uA$$

$$I_{INJP\ AVG} \leq (2mA \times t1) + (100uA \times t2) / (t1 + t2) \leq 150uA$$

**Remark :**

The above mentioned example could also be used for the input pins belonging to Group A with:

$$I_{INJP\ AVG} \leq 400uA$$

**General Cautions:**

1. An Injected Current conditions occur, if the standard operating conditions are exceeded.  
 Example: The input voltage on any pin exceeds the specified range:  
 $V_{IN} > EV_{DD} / V_{DD} / AV_{REF} + 0.3\ V \rightarrow (I_{INJP} > 0)$  or  
 $V_{IN} < EV_{SS} / V_{SS} / AV_{SS} - 0.3\ V \rightarrow (I_{INJN} < 0)$ .  
 $I_{INJP}, I_{INJN}$  = Injected current value that doesn't influence to the operation of the device.
2. The supply voltages must always remain within the specified limits
3. A proper operation is not specified if an Injected Current occurs on the functional pins such as:  
 P121/X1, P122/X2/EXCLK, P123/XT1, P124/XT2/EXCLKS, P137/INTP0, /RESET,  
 P33/ANI0/AVREFP, P34/ANI1/AVREFM, P40/TOOL0
4. The above specifications are not tested in the outgoing inspection, but they are specified based on the design rules and the device characterization
5. If the ANO0 is used as DA converter output there is no injected current allowed on this pin

#### 4. The influence on an adjacent pin caused by the Injected Current

( $T_a = -40$  to  $+150$  °C,  $2.7V \leq EV_{DD0} = EV_{DD1} = V_{DD} \leq 5.5V$ ,  $V_{SS} = EV_{SS0} = EV_{SS1} = 0V$ ) (Note 1)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Leakage current coupling factor for a Positive Injected Current	$K_{INJP}$	Input pins (Group A + B)			$5 \times 10^{-3}$	-
		Input pins (Group C)			$1 \times 10^{-4}$	-
		Input pins (Group D)			(Note 2)	
Leakage current coupling factor for a Negative Injected Current	$K_{INJN}$	Input pins (Group A + B)			$1 \times 10^{-2}$	-
		Input pins (Group C)			$3.2 \times 10^{-3}$	-
		Input pins (Group D)			(Note 2)	

Note 1: 64-pin and 80-pin products have  $EV_{DD0}$ ,  $EV_{SS0}$  and 100-pin product has  $EV_{DD0}$ ,  $EV_{DD1}$ ,  $EV_{SS0}$ ,  $EV_{SS1}$ . For all other products  $EV_{DD0}$  is  $V_{DD}$  and  $EV_{SS0}$  is  $V_{SS}$

Note 2: The following leakage current ( $I_{LINJP}$  or  $I_{LINJN}$ ) could be generated on any pin of Group D when an injected current is input to another pin of Group D:

Parameter	Symbol	Conditions		MIN.	TYP.	MAX.	Unit
Leakage current of adjacent pins caused by a Positive Injected Current (Note 3)	$I_{LINJP}$	Comparator is enabled (HCOMPON =1)	$I_{INJP}=2mA$			-43	uA
			$I_{INJP}=0.15mA$			-10	uA
		Comparator is disabled (HCOMPON =0)	$I_{INJP}=2mA$			-14	uA
			$I_{INJP}=0.15mA$			-1.5	uA
Leakage current of adjacent pins caused by a Negative Injected Current (Note 3)	$I_{LINJN}$	Comparator is enabled (HCOMPON =1)	$I_{INJN}=-0.5mA$			25	uA
		Comparator is disabled (HCOMPON =0)	$I_{INJN}=-0.5mA$			3.5	uA

Note 3: A leakage current ( $I_{LINJP}$ ,  $I_{LINJN}$ ) is generated on the remaining pins of Group D when a current is injected to a pin of Group D.

**Cautions:**

1. An Injected Current through a pin will cause a certain error current in the adjacent pins. This error current must be added to the respective leakage current ( $I_{L\text{IH}} / I_{L\text{IL}}$ ) of the adjacent pins.
2. The amount of error leakage current depends on the Injected Current and it is defined by the coupling factor  $K_{\text{INJ}}$ .
3. The total leakage current through a pin is  $|I_{\text{Ltotal}}| = |I_{\text{LIH}} / I_{\text{LIL}}| + (|I_{\text{INJn}}| \times K_{\text{INJn}})$
4. The additional error current may affect the input voltage on the analog inputs.
5. A proper operation is not specified if an Injected Current occurs on the functional pins such as: P121/X1, P122/X2/EXCLK, P123/XT1, P124/XT2/EXCLKS, P137/INTP0, /RESET, P33/ANI0/AVREFF, P34/ANI1/AVREFM, P40/TOOL0
6. These specifications are not tested in the outgoing inspection, but it is specified based on the design rules and the device characterization
7. If the ANO0 is used as DA converter output there is no injected current allowed on this pin.

## 5. Valid Specification

Item	Date published	Document No.	Document Title
1	May, 2014	R01UH0368EJ0200	RL78/F13, F14 User's Manual: Hardware 16-Bit Single-Chip Microcontrollers

## 6. Revision History

Item	Date published	Document No.	Comment
1	December, 2013	R01TU0061ED0100	1 <sup>st</sup> Release
2	April, 2014	R01TU0061ED0101	1 <sup>st</sup> Update - page 5: move P120 and P125 of 30 and 32 pin device to Port Goup B - page 5: remove P130 from the table because this is output only. - page 6: add EVss1 and EVdd1 to the table and to the notes. - page 8: add EVss1 and EVdd1 to the table and to the notes. - Correct some typos
3	October, 2015	R01TU0061ED0102	2 <sup>nd</sup> Update - page 4: add "Y" to Temperature Grades - pages 6 & 8: Expand the temperature range specification (Ta = -40°C to +150°C)